

VITUS AUDIO - INTRODUCTION OF SIA-030

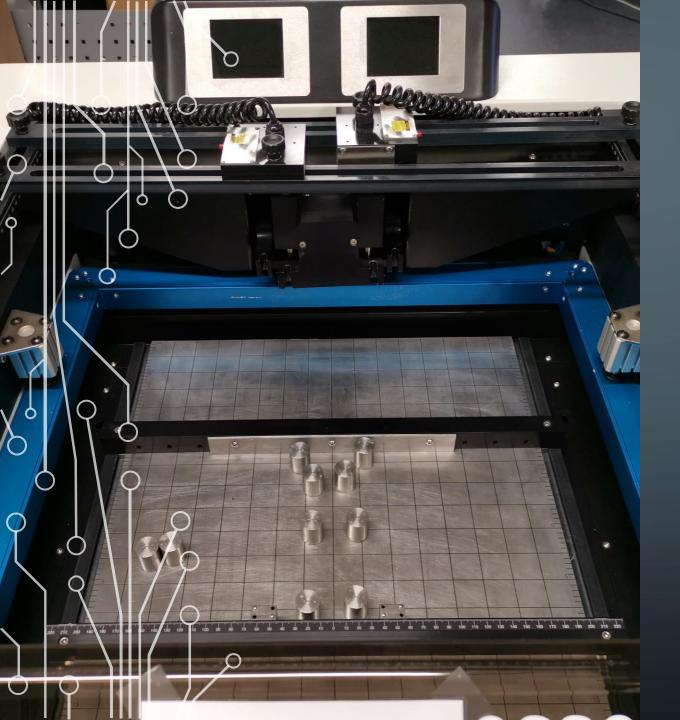
- Built on a foundation of knowhow and inhouse quality production.
 - Approx. 12 years of pedigree in integrated amplifiers
 - In-house PCB production facilities of the highest quality available
- The new SIA-030 preview (To be introduced officially in May 2019)
 - The background, and "motivation"
 - The design
 - Some technical breifs.

THE SIA-030 +12 YEARS PEDIGREE

- 1Q2007 introduced the SS-101 Signature Series
- 3Q2007 introduced the SS-010 Signature Series
- 1Q2010 introduced the SIA-025 Signature Series
- 3Q2010 introduced the RI-100 Reference Series
- 2Q2018 introduced the RI-101 Reference Series
- 2Q2015 introduced the MP-I201 Masterpiece Series
- 2Q2019 introducing the SIA-030 Signature Series only 1,5 years delayed! (original planned release 4Q17)

INHOUSE PRINTED CIRCUITBOARD (PCB) PRODUCTION

- PCB itself is manufactured at a subcontractor.
- All component placement is handled inhouse, with absolute state of the art production machines.
- This gives the highest design prototype re-run to full production flexibility.
- It also provides the fastest re-run time possible (a few days instead of weeks)
- And most importantly it provides the best possible quality overall.



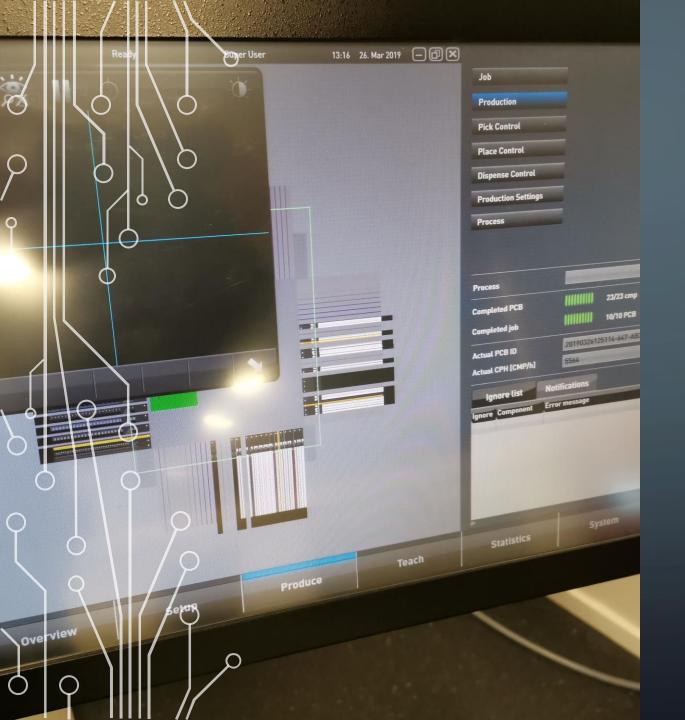
1ST. PROCESS - SCREENING

- Solder paste is added to the board.
- If quality fails here overall quality will suffer, due to bad solderings ect.
- Laser pointers, and vision used to achieve the highest quality possible.
- New and even better machine has been ordered – an investment of another 100.000€



2ND. PROCESS – PLACING COMPONENTS

- Pick & Place machine
- Highest quality available
- Down to smallest component's available today
- Most intelligent MMI
- Highest flexibility possible
- Highest IQ storage communication available.



2ND. PROCESS - MMI

- Best in class MMI
- Gives optimal control, and repeatability
- Super fast and high reliability



3RD. PROCESS - SOLDERING

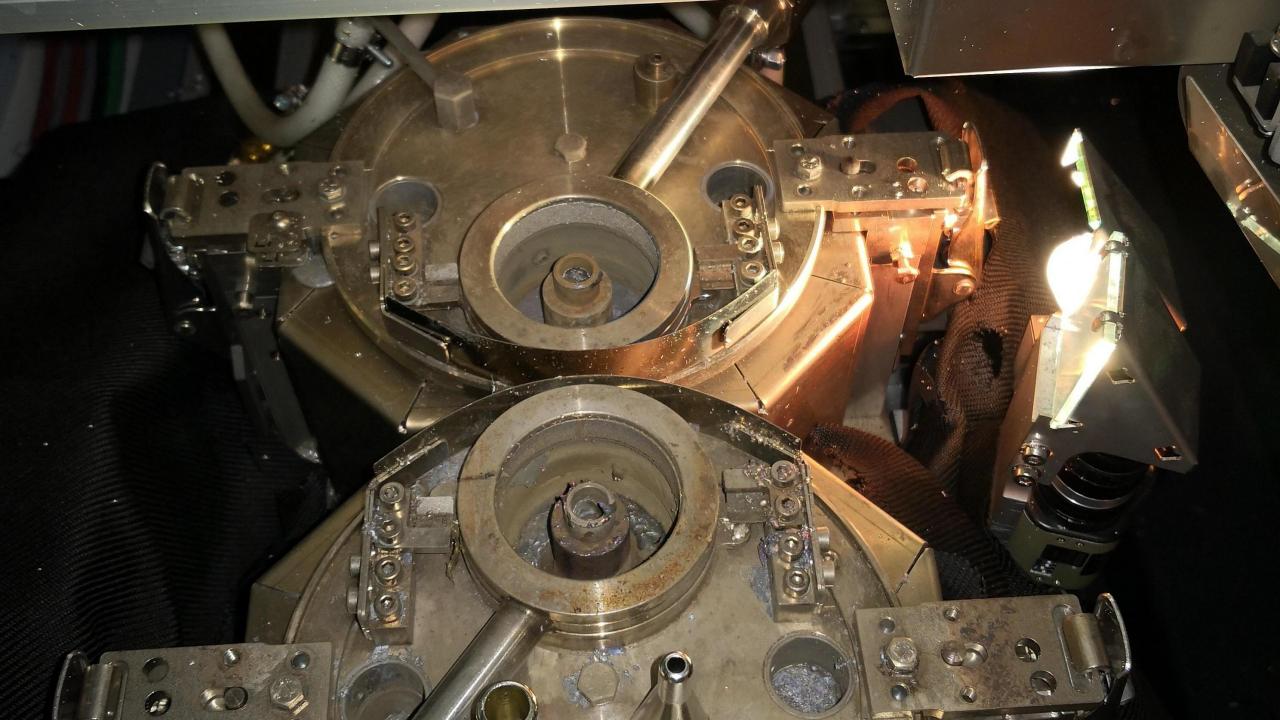
- Vapour Phase soldering of SMD components.
- Primarely used in Space and Mill. Spec products.
- Most reliable soldering available.
- Rarely used due to slow process, and very high price on the machines.





4TH. PROCESS – LEADED SOLDERING

- Selective soldering technology
- Solders through hole (leaded components, like power resistors, capacitors ect.
- Solders each point individually, which gives the best quality leaded soldering
- Adds less stress to components and board, for very high lifetime.





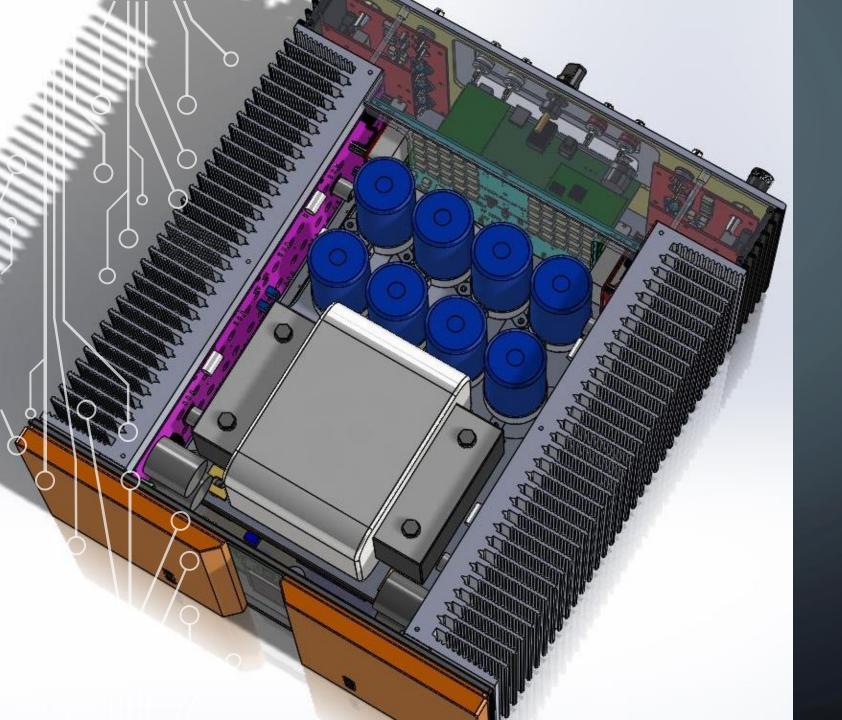
5TH. AND FINAL PROCESS – OPTICAL QC

- The final and very critical stage – Quality Control of the boards
- Stores results in database based on serial# of each board.
- Checks:
 - Soldering quality
 - Orientation of components
 - Correct placement
 - Value of component
 - Ect.



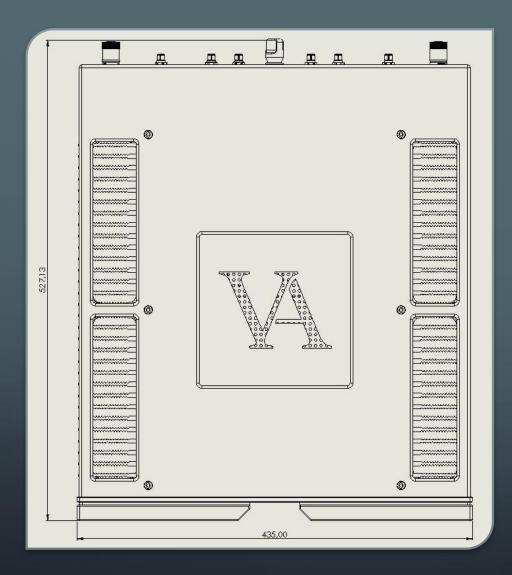
STORAGE.

- All components are stored in correct temperature, humidity and air pressure
- Intelligent communication on amount of all components on stock with Pick & Place machine.
- Intelligent communication with ERP system, for placing purchase orders.
- Safeguards ease of production flow, lifetime of components.

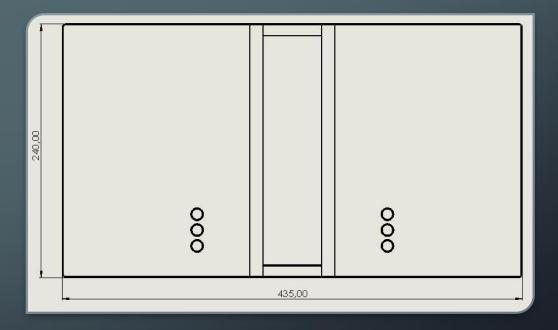


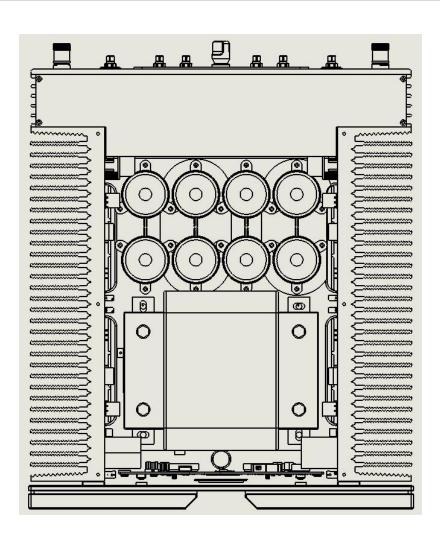
PREVIEW OF THE SIA-030

- Overview of mechanical design
- Overview of specification
- Overview of functionality
- Overview of options.



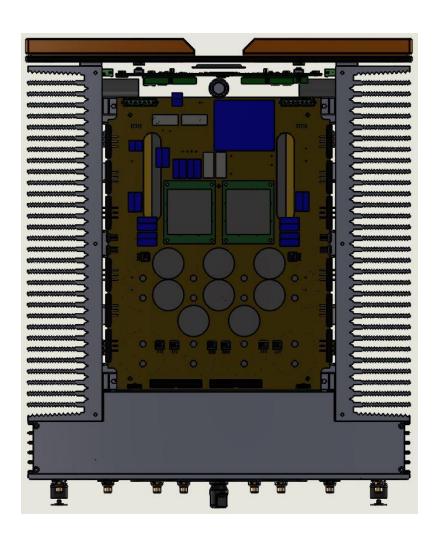
Mechanical size (WxHxD): 435x268x530mm Expected final weight: approx 55kg.





INTERNAL OVERVIEW - TOPSIDE

- 2.2KVA custom design transformer, vibration suspended.
- Approx. 400.000uF precapacitor bank
- Shielded preamplifier internal "chassis"
- Airflow optimized for maximum cooling with no fans.



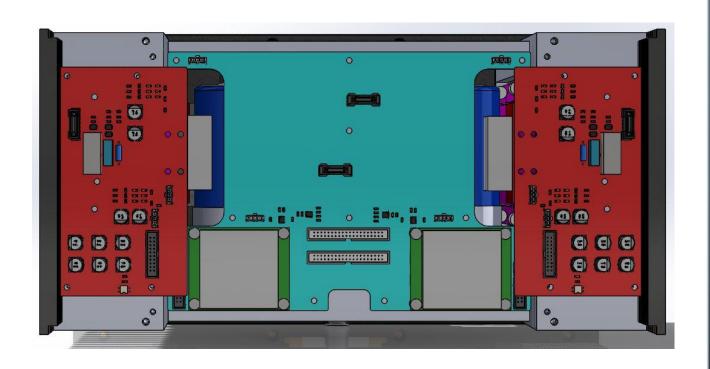
INTERNAL OVERVIEW - BOTTOM SIDE

- Extra transformer for all logic/CPU ect.
- Secondary capacitor bank of approx. 216.000uF
- Fully regulated PSU, also for output stage – similar to what is found in our MP-M201 4 chassis mono amplifiers.
- Key regulation technology insulated in add-on modules for easy upgradability, and extra shielding.



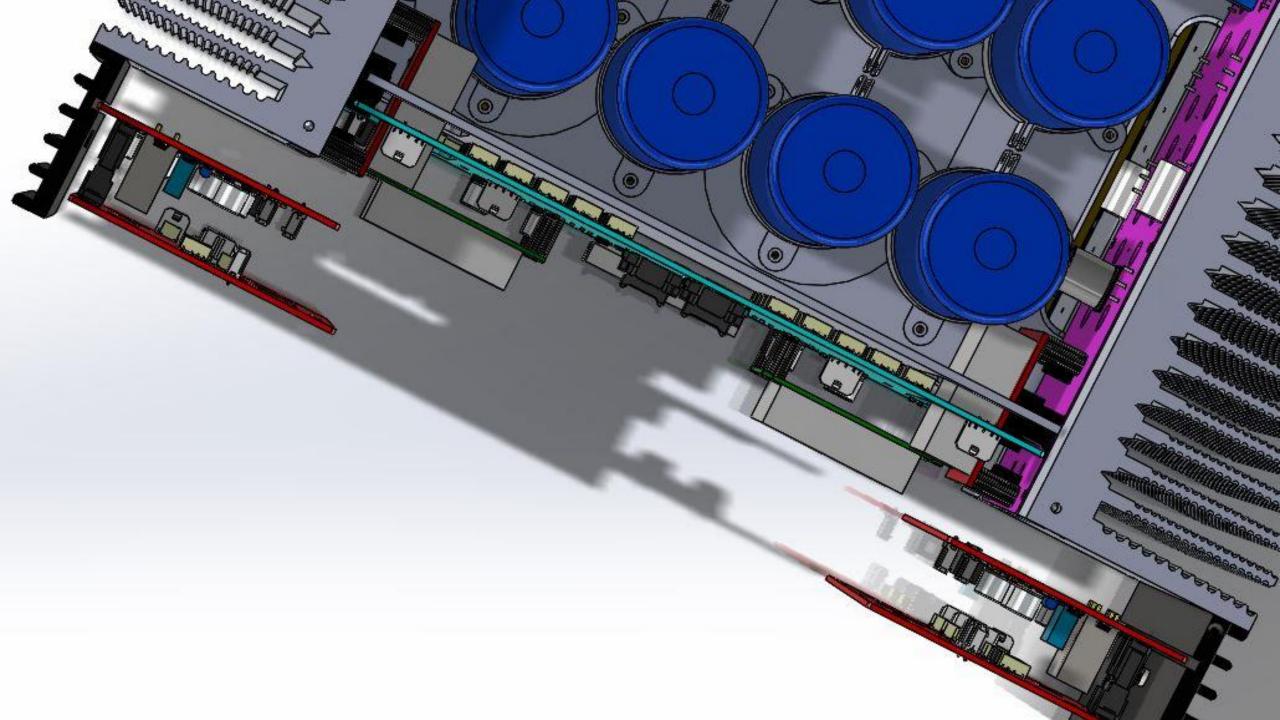
THE REAR PLATE

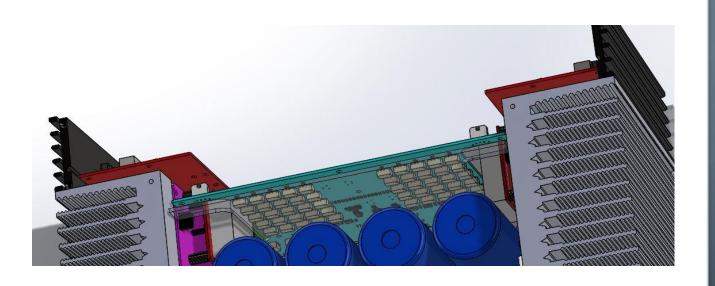
- Everything separated nicely, and in complete mirror configuration
- Standard inputs: 2x RCA unbalanced and 3x XLR fully balanced line inputs.
- Speaker Outputs are true balanced.
- Pre-out un-balanced to be compatible with most active subs.
- RJ45/USB logical inputs for easy firmware upgrades.
- Optional Phono stage and DAC/Streamer.



PREAMP SECTION

- Separate input selection board. Placed directly @ input connectors.
- Main preamp board paced at shield plate, which offers good shielding from especially power transformer.
- As usual using our modular design, for easy future upgrades.





THE VOLUME CONTROL

- Placed on the back of the preamplifier board.
- New design taken from the MP-L201.
- Offers 0.5dB steps on every step.
- Signal path approx. 20mm though complete volume.
- Zero influence on bandwidth.



SUMMARY AND SPECS

INPUTS:

Linestage:

- 2x unbalanced RCA inputs
- 3x true balanced XRL inputs

Optional Phono stage:

2x unbalanced RCA inputs

Optional DAC/Streamer:

- 1x AES input
- 1x SPDIF (RCA) input
- 1x Ethernet for streaming
- 1x USB supporting upto 2x DSD
- 1x Optical input for TV ect.

OUTPUTS:

- 1 set balanced speaker outputs
- 1x unbalanced RCA pre-out for active subs or bi-amping

SPECIFICATIONS:

- 30W kl.A in 8ohm RMS
- 200W high biased kl. AB in 8 ohm RMS.
- Powerrating almost doubles for 4 ohm
- Kl. A / AB mode switchable
- Fully regulated PSU including output stage
- Linestage gain upto 12-18dB
- Phonostage supports MC/MM with max gain upto 70dB (expected)









THANK YOU FOR LISTENING!

..... And remember:

Listen to music, not equipment!

Rgds

The Vitus Audio / employee band ©